



Lunch
with us

ZEISS Lunch & Learn session – Wafer Intra-Field Solutions for DUV

Lunch with us and learn more about wafer intra-field solutions for DUV. Take-off and explore ZEISS ForTune technology, main use cases and reveal real results for both CDU & Overlay control.

Where: Oriental Riverside Hotel, 1F Shanghai Night 东方滨江大酒店 1楼上海之夜

When: Tuesday March 19th 2019

Time: 12:15 – 13:30pm

Speaker: Ofir Sharoni, Director Product Management / Tuning FoB

Delicious Lunch will be served. Please register [here](#) for the event until March 12th

www.zeiss.com/mask-solutions

